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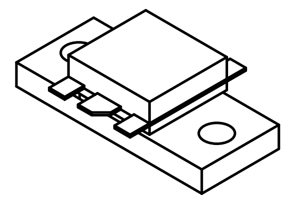
The RF Line
NPN Silicon RF Power Transistor

MRF898

. . . designed for 24 Volt UHF large–signal, common base amplifier applications in industrial and commercial FM equipment operating in the range of 850–960 MHz.

- Motorola Advanced Amplifier Concept Package
- Specified 24 Volt, 900 MHz Characteristics
  Output Power = 60 Watts
  Power Gain = 7.0 dB Min
  Efficiency = 60% Min
- Double Input/Output Matched for Wideband Performance and Simplified External Matching
- Series Equivalent Large–Signal Characterization
- Gold Metallized, Emitter Ballasted for Long Life and Resistance to Metal Migration
- Silicon Nitride Passivated
- Circuit board photomaster available upon request by contacting RF Tactical Marketing in Phoenix, AZ.

**60 W, 850–960 MHz
RF POWER
TRANSISTOR
NPN SILICON**



CASE 333A–02, STYLE 1

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	V_{CEO}	30	Vdc
Collector–Base Voltage	V_{CBO}	55	Vdc
Emitter–Base Voltage	V_{EBO}	4.0	Vdc
Collector Current — Continuous	I_C	10	Adc
Total Device Dissipation @ T_C = 25°C Derate above 25°C	P_D	175 1.0	Watts W/°C
Storage Temperature Range	T_{stg}	–65 to +150	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.0	°C/W

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Collector–Emitter Breakdown Voltage (I_C = 50 mAdc, I_B = 0)	$V_{(BR)CEO}$	30	—	—	Vdc
Collector–Emitter Breakdown Voltage (I_C = 50 mAdc, V_{BE} = 0)	$V_{(BR)CES}$	55	—	—	Vdc
Emitter–Base Breakdown Voltage (I_E = 5.0 mAdc, I_C = 0)	$V_{(BR)EBO}$	4.0	—	—	Vdc
Collector Cutoff Current (V_{CE} = 30 Vdc, V_{BE} = 0, T_C = 25°C)	I_{CES}	—	—	10	mAdc

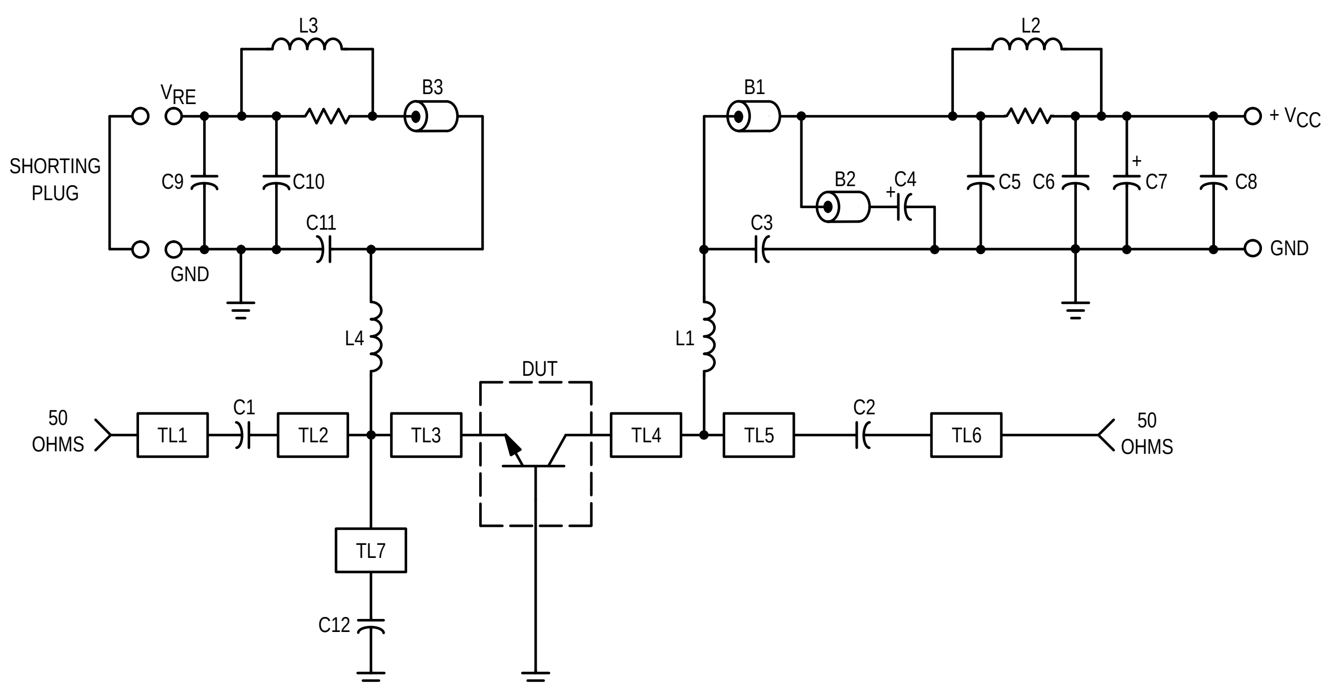
(continued)

REV 6

ELECTRICAL CHARACTERISTICS — continued (T_C = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
ON CHARACTERISTICS					
DC Current Gain (I_C = 2.0 Adc, V_{CE} = 5.0 Vdc)	h_{FE}	20	50	150	—
DYNAMIC CHARACTERISTICS					
Output Capacitance (1) (V_{CB} = 24 Vdc, I_E = 0, f = 1.0 MHz)	C_{ob}	—	60	—	pF
FUNCTIONAL TESTS					
Common–Base Amplifier Power Gain (V_{CC} = 24 Vdc, P_{out} = 60 W, f = 900 MHz)	G_{pb}	7.0	7.9	—	dB
Collector Efficiency (V_{CC} = 24 Vdc, P_{out} = 60 W, f = 900 MHz)	η	60	65	—	%
Output Mismatch Stress (V_{CC} = 24 Vdc, P_{out} = 60 W, f = 900 MHz, VSWR = 5:1, all phase angles)	ψ	No Degradation in Output Power			

NOTE:
1. Value of "C_{ob}" is that of die only. It is not measurable in MRF898 because of internal matching network.



B1, B2, B3 — Bead, Ferroxcube 56–390–65/3B
C1, C2, C12 — 39 pF, 100 Mil Chip Capacitor
C3, C11 — 91 pF, Mini Underwood or Equivalent
C4, C7, C9 — 10 µF, 35 V Electrolytic
C5 — 4000 pF, 1.0 kV Ceramic
C6, C10 — 1000 pF, 350 V Unelco or Equivalent
C8 — 47 pF, 100 Mil Chip Capacitor
L1, L4 — 4 Turns #18 AWG Choke
L2 — 11 Turns #20 AWG Choke on 10 Ohm, 1.0 Watt Resistor
L3 — 3 Turns #18 AWG Choke on 10 Ohm, 1.0 Watt Resistor

TL1, TL6 — 50 Ohm Microstrip
TL2 — 400 x 950 Mils
TL3, TL4 — 140 x 200 Mils
TL5 — 320 x 690 Mils
TL7 — 260 x 230 Mils

Board — 3M Epsilam–10, 50 Mil
Bias Boards — 1/32″ G10 or Equivalent

Figure 1. 850 – 960 MHz Broadband Test Circuit

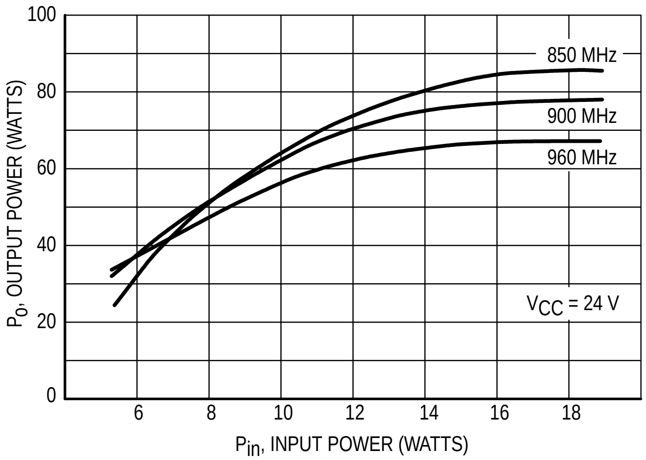


Figure 2. Output Power versus Input Power

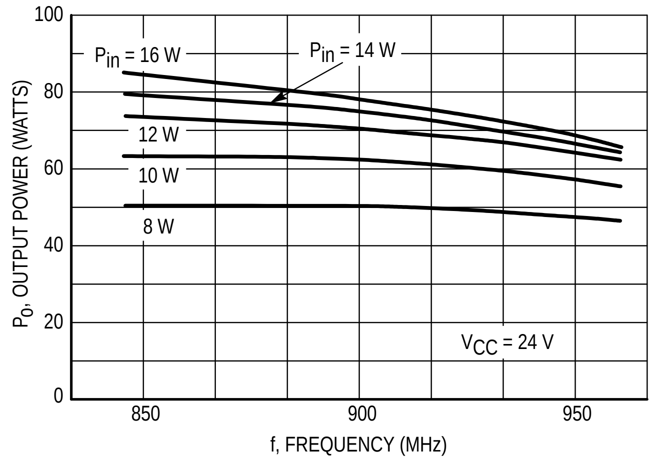


Figure 3. Output Power versus Frequency

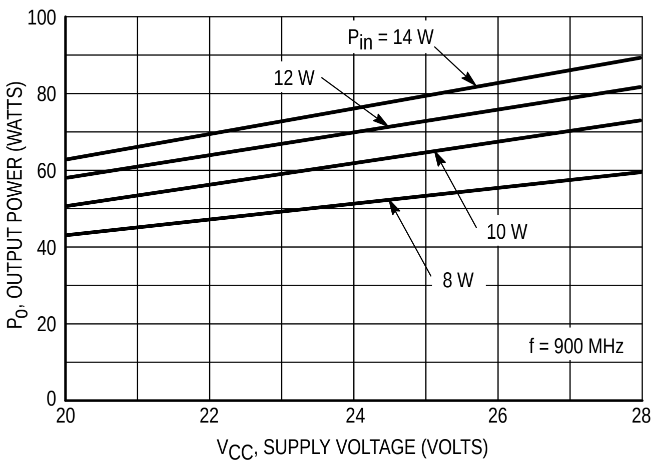


Figure 4. Output Power versus Supply Voltage

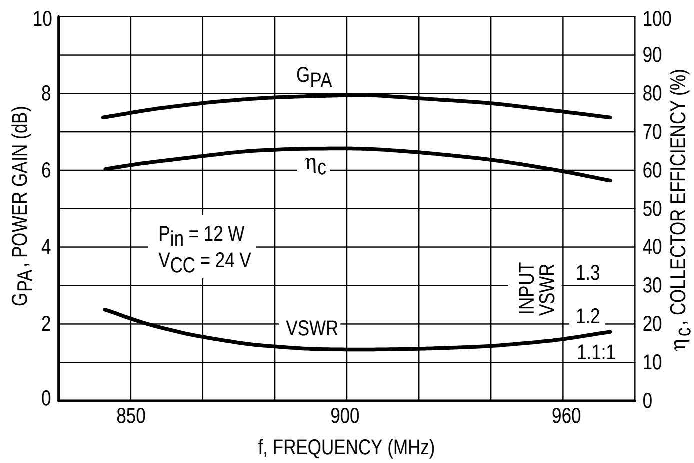
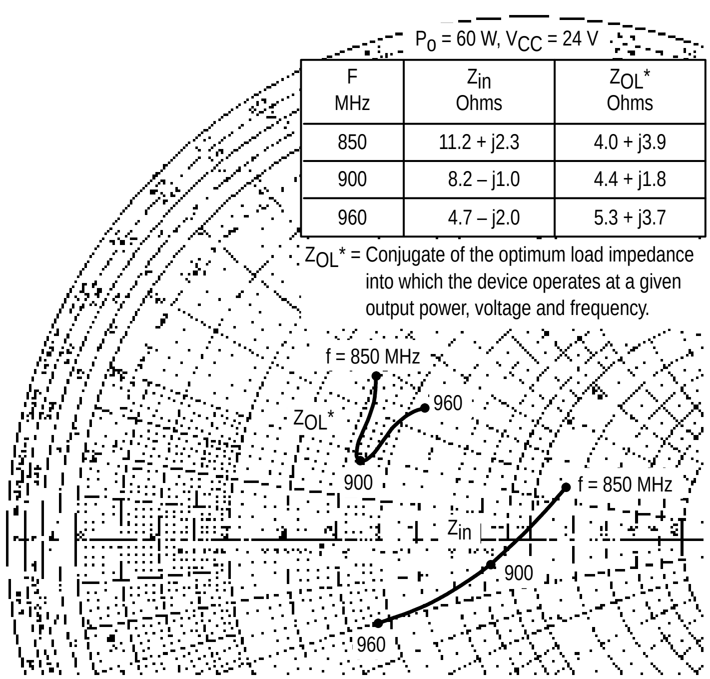


Figure 5. Typical Broadband Circuit Performance



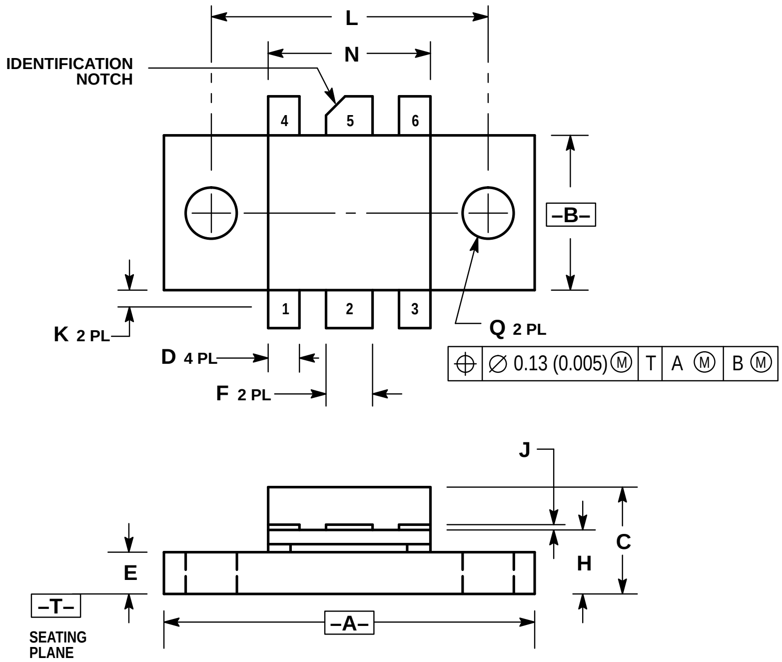
P_o = 60 W, V_{CC} = 24 V

F MHz	Z_{in} Ohms	Z_{OL}* Ohms
850	11.2 + j2.3	4.0 + j3.9
900	8.2 – j1.0	4.4 + j1.8
960	4.7 – j2.0	5.3 + j3.7

Z_{OL}* = Conjugate of the optimum load impedance into which the device operates at a given output power, voltage and frequency.

Figure 6. Input/Output Impedance versus Frequency

PACKAGE DIMENSIONS



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.965	0.985	24.52	25.01
B	0.390	0.410	9.91	10.41
C	0.250	0.290	6.35	7.36
D	0.075	0.090	1.91	2.28
E	0.095	0.115	2.42	2.92
F	0.110	0.130	2.80	3.30
H	0.155	0.175	3.94	4.44
J	0.004	0.006	0.11	0.15
K	0.090	0.116	2.29	2.94
L	0.725 BSC		18.41 BSC	
N	0.415	0.435	10.55	11.04
Q	0.120	0.135	3.05	3.42

STYLE 1:
PIN 1. BASE
2. EMITTER
3. BASE
4. BASE
5. COLLECTOR
6. BASE

CASE 333A–02
ISSUE C

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